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Vishay Siliconix

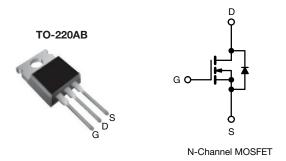
RoHS

COMPLIANT HALOGEN

FREE

EF Series Power MOSFET with Fast Body Diode

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V 0.123			
Q _g (Max.) (nC)	120			
Q _{gs} (nC)	17			
Q _{gd} (nC)	33			
Configuration	Single			



FEATURES

- Fast body diode MOSFET using E series technology
- Reduced t_{rr}, Q_{rr}, and I_{RRM}
- Low figure-of-merit (FOM): Ron x Qg
- Low input capacitance (Ciss)
- Low switching losses due to reduced Q_{rr}
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High intensity discharge (HID)
 - Light emitting diodes (LEDs)
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power suppliers (SMPS)
- Applications using the following topologies
 - LLC
 - Phase shifted bridge (ZVS)
 - 3-level inverter
 - AC/DC bridge

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and Halogen-free	SiHP28N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	600	.,		
Gate-Source Voltage			V_{GS}	± 30	V	
Continuous Drain Current (T _{.I} = 150 °C)	V _{GS} at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	l _D	28	А	
Continuous Drain Current (1 _J = 150 °C)		T _C = 100 °C		18		
Pulsed Drain Current ^a		I _{DM}	75	1		
Linear Derating Factor				2	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	691	mJ	
Maximum Power Dissipation			P _D	250	W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope T _J = 125 °C		dV/dt	70	V/ns		
Reverse Diode dV/dt ^d			50			
Soldering Recommendations (Peak Temperature) c	Recommendations (Peak Temperature) c for 10 s			300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 7 A
- c. 1.6 mm from case
- d. $I_{SD} \le I_D$, $dI/dt = 900 \text{ A/}\mu\text{s}$, starting $T_J = 25 \,^{\circ}\text{C}$



Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.5	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static		•			•	l .	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = 1 mA	-	0.76	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μA	2.0	-	4.0	V
Coto Course Leekens		V _{GS} = ± 20 V		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 1	μΑ
Zava Cata Valtaga Dvain Curvant		V _{DS} =	= 480 V, V _{GS} = 0 V	-	-	1	μΑ
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 480 V, V _{GS} = 0 V V _{DS} = 480 V, V _{GS} = 0 V, T _J = 125 °C		-	-	2	mA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 14 A	-	0.107	0.123	Ω
Forward Transconductance	9 _{fs}	V_{DS}	= 30 V, I _D = 14 A	-	9.7	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2714	-	
Output Capacitance	C _{oss}		$V_{DS} = 100 V,$	_	123	_	1
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	6	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{GS} = 0 V, V _{DS} = 0 V to 480 V		pF			
Effective output capacitance, time related b	C _{o(tr)}	45	, 50	-	356	-	1
Total Gate Charge	Qg			-	80	120	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$	$I_D = 14 A, V_{DS} = 480 V$	-	17	-	nC
Gate-Drain Charge	Q _{gd}			-	33	-	
Turn-On Delay Time	t _{d(on)}			-	24	48	
Rise Time	t _r	V _{DD} = 480 V, I _D = 14 A		-	40	80]
Turn-Off Delay Time	t _{d(off)}		9.1 Ω , $V_{GS} = 10 \text{ V}$	-	82	123	ns
Fall Time	t _f			-	39	78	
Gate Input Resistance	R _g	f = 1	MHz, open drain	0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristics							
Continuous Source-Drain Diode Current	Is	MOSFET syml showing the	ool	-	-	28	^
Pulsed Diode Forward Current	I _{SM}	integral reverse p - n junction diode		-	-	70	- A
Diode Forward Voltage	V _{SD}	$T_J = 25 ^{\circ}\text{C}, I_S = 11 \text{A}, V_{GS} = 0 \text{V}$		-	0.9	1.2	V
Reverse Recovery Time	t _{rr}			-	142	284	ns
Reverse Recovery Charge	Q _{rr}	T ₁ = 25 °C ₅ = 1 ₀ = 14 Δ		1.94	μC		
Reverse Recovery Current	I _{RRM}	ui/dt =	100 AV µS, VR = 400 V	-	13.2	-	Α

Notes

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

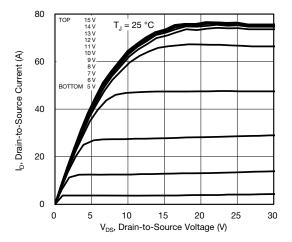


Fig. 1 - Typical Output Characteristics

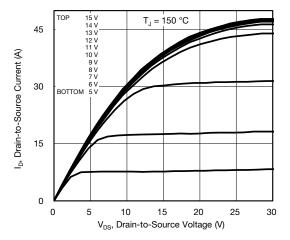


Fig. 2 - Typical Output Characteristics

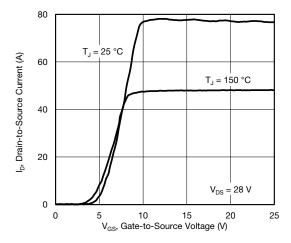


Fig. 3 - Typical Transfer Characteristics

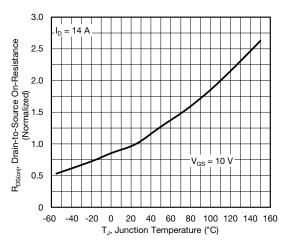


Fig. 4 - Normalized On-Resistance vs. Temperature

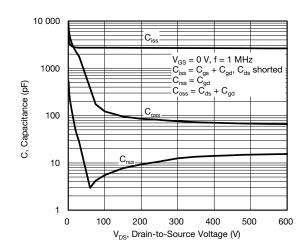


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

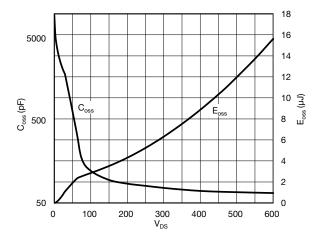


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}



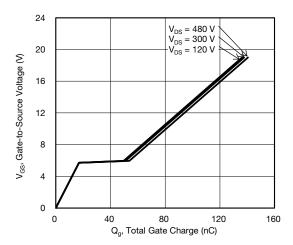


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

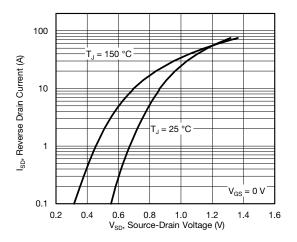


Fig. 8 - Typical Source-Drain Diode Forward Voltage

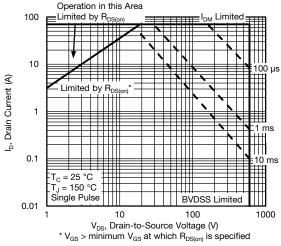


Fig. 9 - Maximum Safe Operating Area

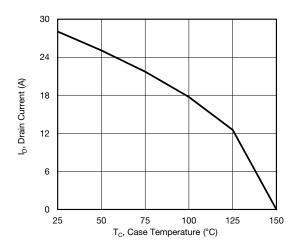


Fig. 10 - Maximum Drain Current vs. Case Temperature

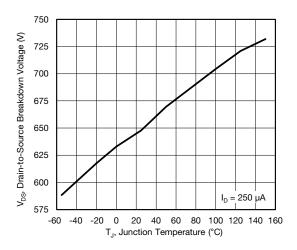


Fig. 11 - Typical Drain-to-Source Voltage vs. Temperature



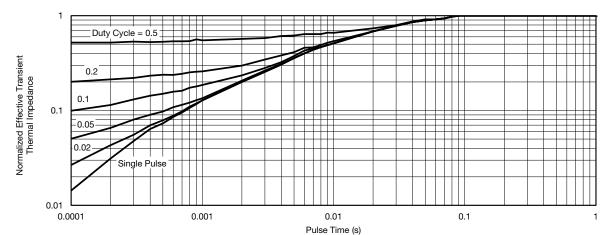


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

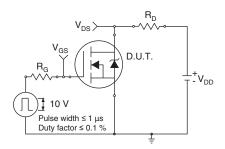


Fig. 13 - Switching Time Test Circuit

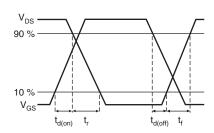


Fig. 14 - Switching Time Waveforms

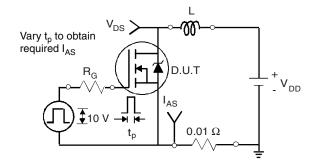


Fig. 15 - Unclamped Inductive Test Circuit

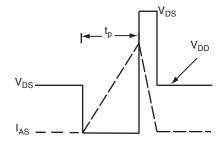


Fig. 16 - Unclamped Inductive Waveforms

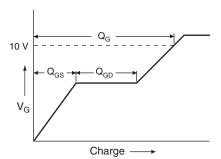


Fig. 17 - Basic Gate Charge Waveform

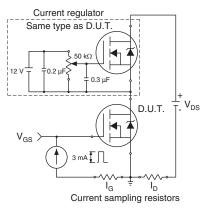
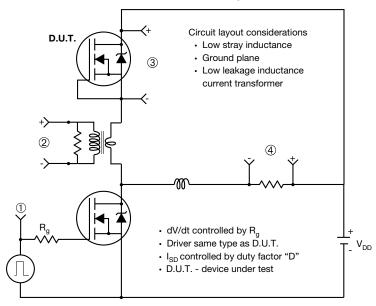


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



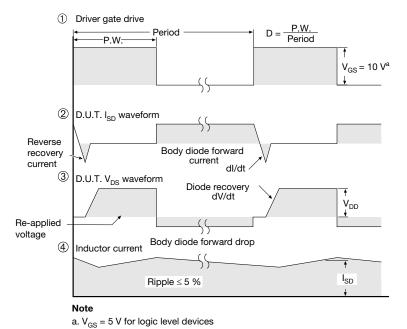


Fig. 19 - For N-Channel

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TO-220-1



DIM.	MILLIN	METERS	INCHES		
DIW.	MIN.	MAX.	MIN.	MAX.	
Α	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	

Note

 \bullet $M^{\star}=0.052$ inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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